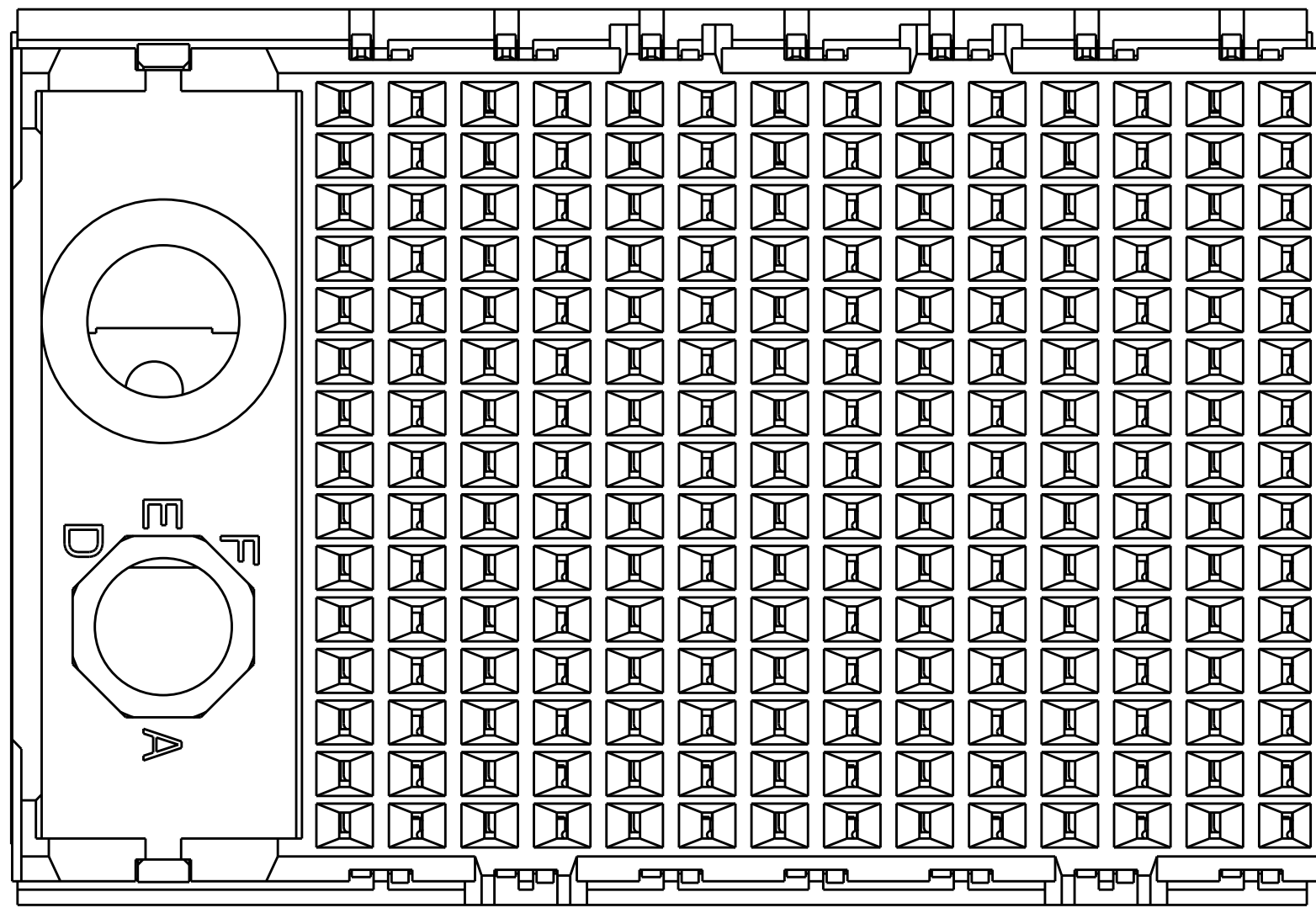
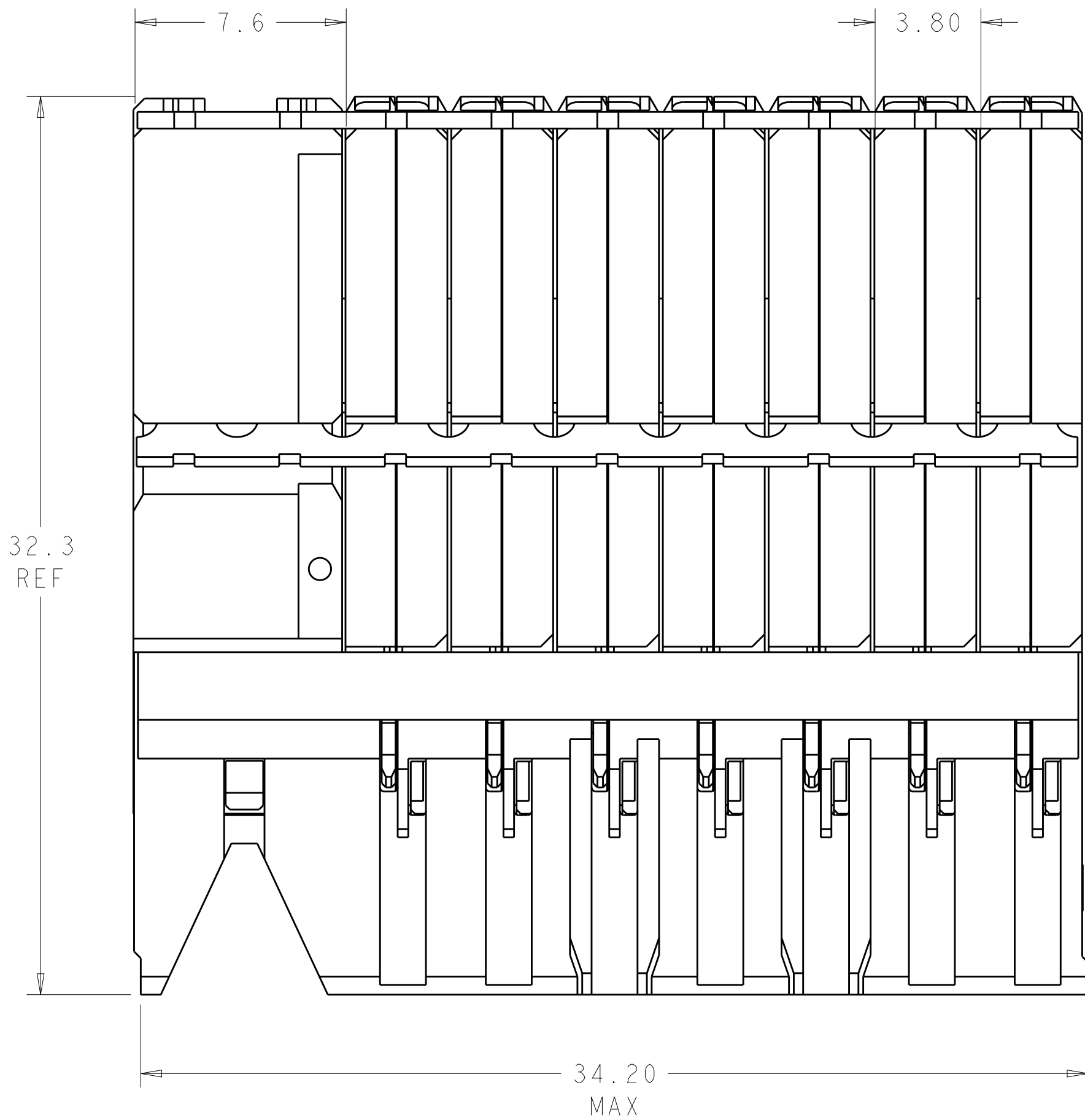


D

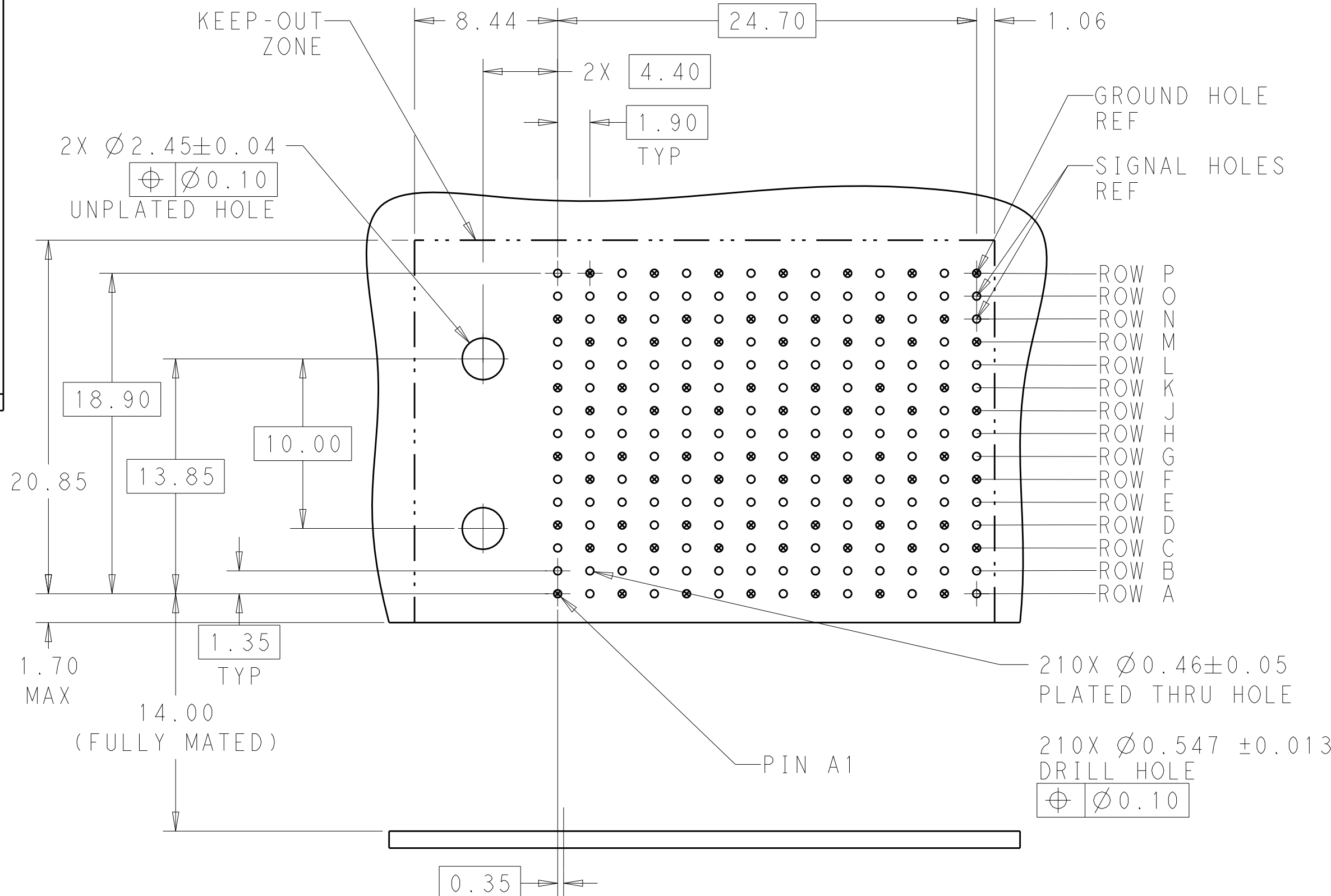
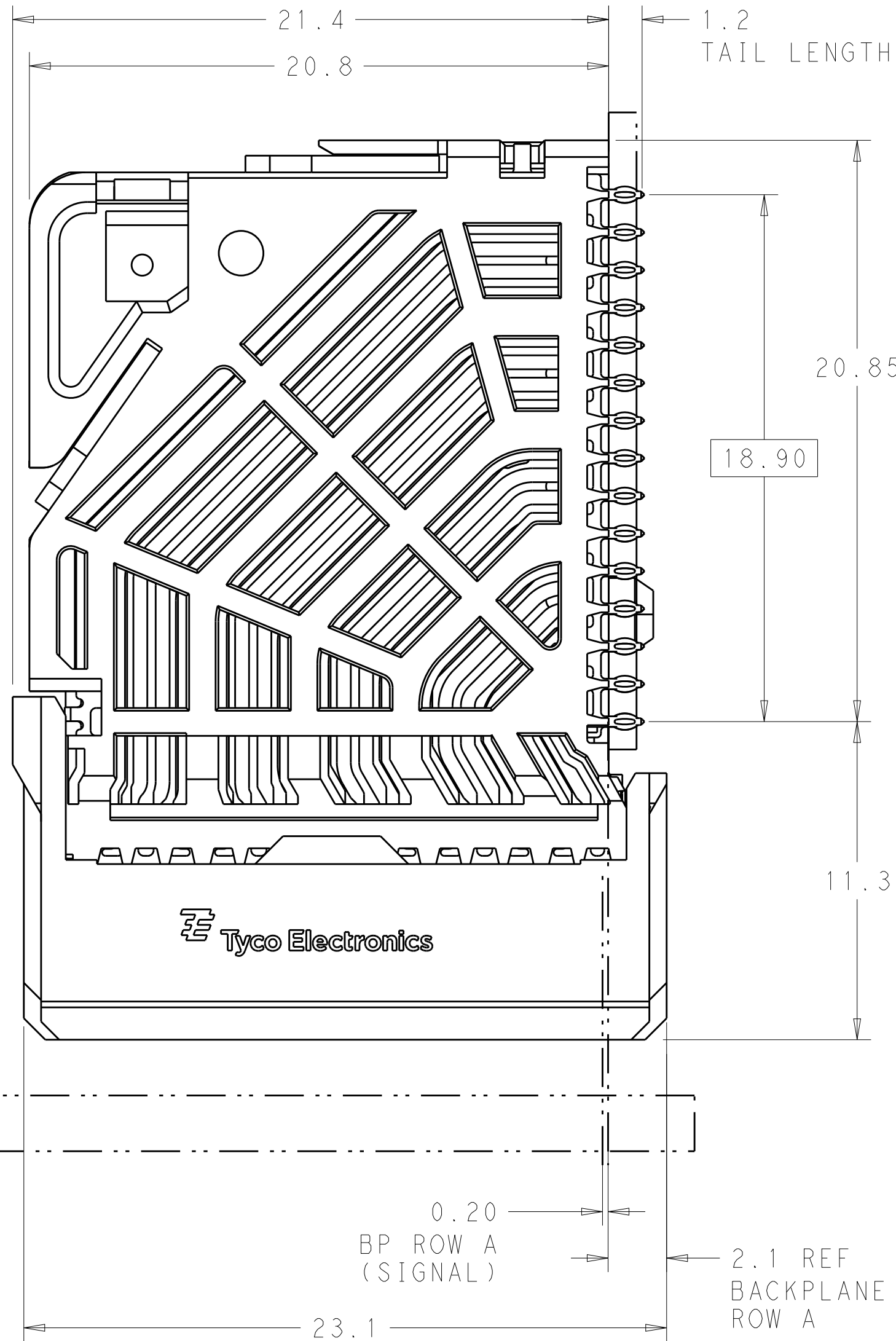
C

B

A



KEY POSITION CHART	
	NONE
	A
	E
	B
	F
	C
	G
	D
	H

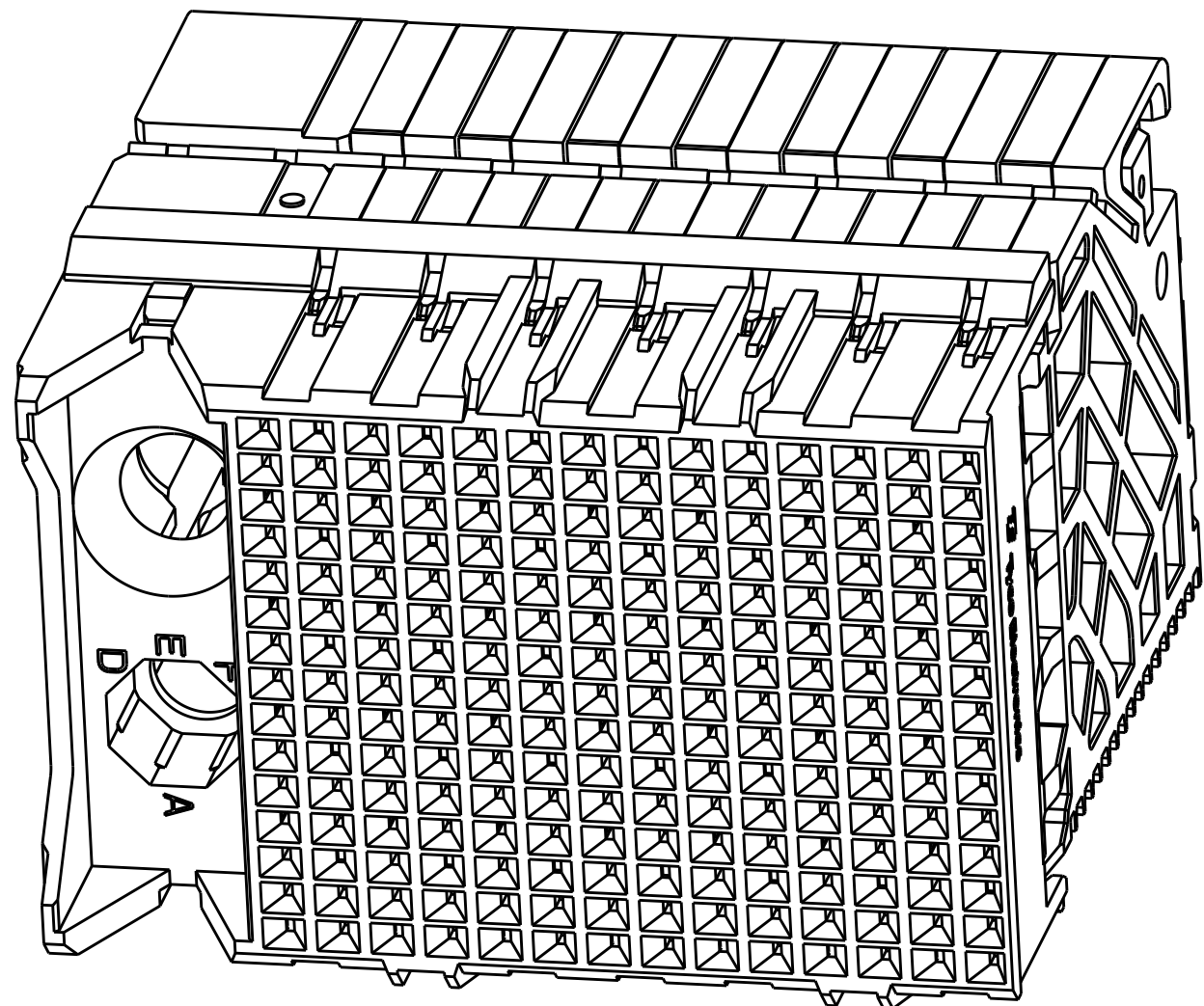


OFFSET BETWEEN BOARD AND BACKPLANE HOLE COLUMNS

RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.0

REVISIONS				
P	LTR	DESCRIPTION	DATE	DWN
B		REVISED PER ECO-15-004915	09APR2015	AP
				DD

- 1 MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.
- 2 FINISH:
30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL.
3. CONNECTORS SUPPLIED WITH MOUNTING SCREWS.



SCALE 4:1

REFER TO WWW.TE.COM
FOR PRODUCT AVAILABILITY

H	2	8-2110113-1
G	2	7-2110113-1
F	2	6-2110113-1
E	2	5-2110113-1
D	2	4-2110113-1
C	2	3-2110113-1
B	2	2-2110113-1
A	2	1-2110113-1
NONE	2	2110113-1
KEY POSITION	FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN: KIRAN HOLAL 10NOV2012	TE Connectivity	
DIMENSIONS:		CHK: D. DIXON 10NOV2012		
mm	TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD: D. DIXON 10NOV2012	NAME	
	0 PLC ±	PRODUCT SPEC	IMPACT, 5 PAIR, DAUGHTERCARD 14 COLUMN, LEFT GUIDED, SIGNAL MODULE, 0.46 EYELET	
	1 PLC ±0.2	APPLICATION SPEC		
	2 PLC ±0.13		SIZE CAGE CODE DRAWING NO	
	3 PLC ±		A100779C=2110113	
	4 PLC ±		RESTRICTED TO	
MATERIAL	FINISH	WEIGHT	Customer Drawing	
	SEE TABLE		SCALE 6:1 SHEET 1 OF 1 REV B	